

ATTY DKT. NO.: AMAT/5191C1/ISM/CORE/MCVD/PJS
U.S. SERIAL NO.: UNKNOWN CONF. NO.: UNKNOWN
FILED: HEREWITH
APPLICANT: APPLIED MATERIALS, INC.
TITLE: APPARATUS AND METHOD FOR VAPORIZING SOLID PRECURSOR FOR
CVD OR ATOMIC LAYER
INVENTOR: LAWRENCE CHUNG-LAI LEI
EXPRESS MAIL No.: EV416701885OUS

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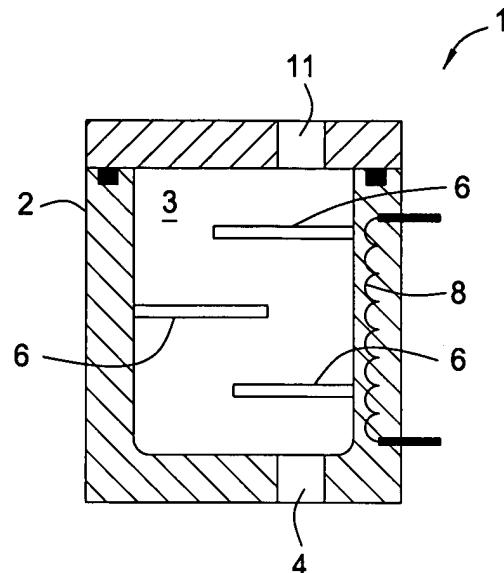


FIG. 1

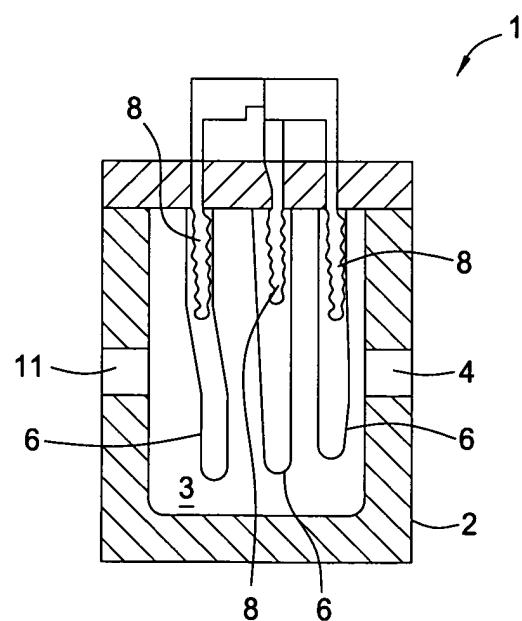


FIG. 2

ATTY DKT. No.: AMAT/5191C1/ISM/CORE/MCVD/PJS
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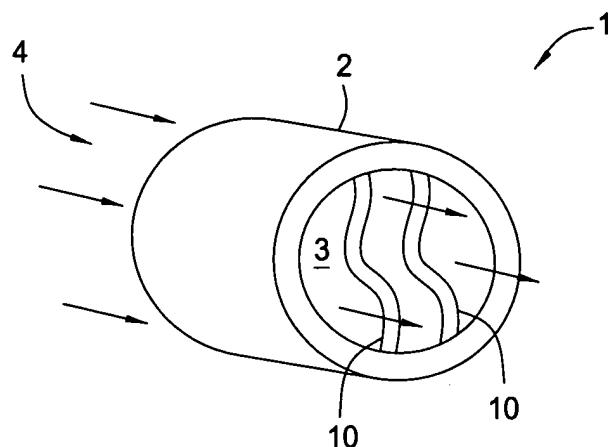


FIG. 3

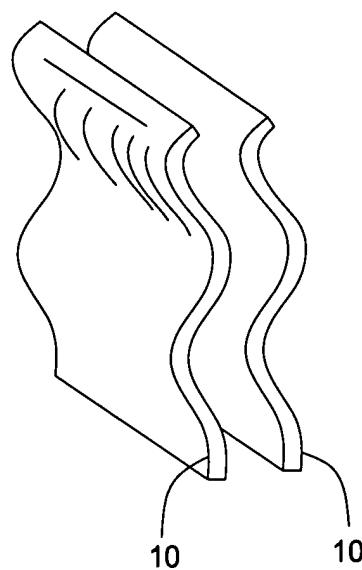


FIG. 4

ATTY DKT. NO.: AMAT/5191C1/ISM/CORE/MCVD/PJS
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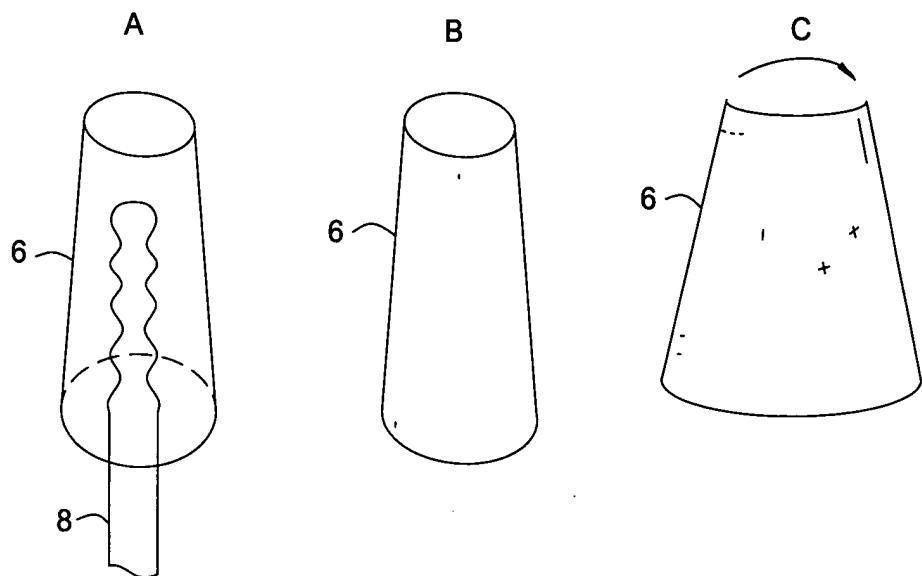


FIG. 5